

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT								
NATURE OF CONVEYANCE:	ASSIGNMENT								
CONVEYING PARTY DATA									
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>JIN-GONG MENG</td><td>08/10/2007</td></tr><tr><td>CHING-BAI HWANG</td><td>08/10/2007</td></tr></tbody></table>	Name	Execution Date	JIN-GONG MENG	08/10/2007	CHING-BAI HWANG	08/10/2007			
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<table border="1"><tr><td>Name:</td><td>Fu Zhun Precision Industry (Shen Zhen) Co., Ltd.</td></tr><tr><td>Street Address:</td><td>No. 2, 2nd Donghuan Road, Longhua Town, Bao' an District</td></tr><tr><td>City:</td><td>Shenzhen City, Guangdong Province</td></tr><tr><td>State/Country:</td><td>CHINA</td></tr></table>	Name:	Fu Zhun Precision Industry (Shen Zhen) Co., Ltd.	Street Address:	No. 2, 2nd Donghuan Road, Longhua Town, Bao' an District	City:	Shenzhen City, Guangdong Province	State/Country:	CHINA	
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<table border="1"><tr><td>Name:</td><td>Foxconn Technology Co., Ltd.</td></tr><tr><td>Street Address:</td><td>3-2, CHUNG SHAN ROAD</td></tr><tr><td>City:</td><td>Tu-Cheng, Taipei Hsien</td></tr><tr><td>State/Country:</td><td>TAIWAN</td></tr></table>	Name:	Foxconn Technology Co., Ltd.	Street Address:	3-2, CHUNG SHAN ROAD	City:	Tu-Cheng, Taipei Hsien	State/Country:	TAIWAN	
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State/Country:	TAIWAN								
PROPERTY NUMBERS Total: 1									
<table border="1"><thead><tr><th>Property Type</th><th>Number</th></tr></thead><tbody><tr><td>Application Number:</td><td>11840178</td></tr></tbody></table>	Property Type	Number	Application Number:	11840178					
Property Type	Number								
Application Number:	11840178								
CORRESPONDENCE DATA									
Fax Number: (714)738-4649 <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>									
Phone: (714)626-1229									
Email: jtknapp@foxconn.com									
Correspondent Name: Jeffrey Knapp									
Address Line 1: 458 E. Lambert Road									
Address Line 4: Fullerton, CALIFORNIA 92835									
ATTORNEY DOCKET NUMBER:	US14537								
NAME OF SUBMITTER:	Jeffrey Todd Knapp								

CH \$40.00 11840178

PATENT

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REEL: 019707 FRAME: 0644

Total Attachments: 2

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ASSIGNMENT

In consideration of value received, the receipt and sufficiency of which are hereby acknowledged, the undersigned ASSIGNOR(S)

1. Jin-Gong Meng , residing at Shenzhen,Guangdong, China
2. Ching-Bai Hwang , residing at Tu-Cheng, Taipei, Taiwan
3. _____ , residing at _____
4. _____ , residing at _____
5. _____ , residing at _____
6. _____ , residing at _____
7. _____ , residing at _____
8. _____ , residing at _____

hereby sell(s), assign(s) and transfer(s) unto: Fu Zhun Precision Industry (Shen Zhen) Co., Ltd. having a principal place of business at No.2, 2nd Donghuan Road, Longhua Town, Bao'an District, Shenzhen City, Guangdong Province 518109, P.R.C. and Foxconn Technology Co., Ltd. having a principal place of business at 3-2, Chung Shan Road, Tu-Cheng City, Taipei Hsien, Taiwan, R.O.C. hereafter designated "ASSIGNEE" the entire right, title and interest for the United States of America as defined in 35 U.S.C. 100, in the invention and all patent applications including any and all divisions, continuations, substitutes, and reissues thereof, and all resulting patents, known as THERMAL MODULE WITH POROUS TYPE HEAT DISSIPATER for which the undersigned

[] previously executed --- Ser. No. _____ and filing date of _____
[x] is executing concurrently herewith

an application for Letters Patent of United States of America

AND the undersigned hereby authorize(s) and request(s) the United States Commissioner of Patents and Trademarks to issue said Letters Patent to the said ASSIGNEE, for its interest as ASSIGNEE, its successors, assigns and legal representatives; the undersigned agree(s) that the attorneys of record in said application, if any, shall hereafter act on behalf of said ASSIGNEE;

AND the undersigned hereby agree(s) to testify and execute any papers for ASSIGNEE, its successors, assigns and legal representatives, deemed essential by ASSIGNEE to ASSIGNEE's full protection and title in and to the invention hereby transferred.

PATENT

REEL: 019707 FRAME: 0646

1. Jin-Gong Meng
Jin-Gong Meng inventor

Aug. 10, 2007

Date

Witness

2. Ching-Bai Hwang
Ching-Bai Hwang inventor

Aug. 10, 2007

Date

Witness

3. _____
inventor

Date

Witness

4. _____
inventor

Date

Witness

5. _____
inventor

Date

Witness

6. _____
inventor

Date

Witness

7. _____
inventor

Date

Witness

8. _____
inventor

Date

Witness